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## **ON Semiconductor**®

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**ON Semiconductor®** 

SuperFET<sup>®</sup> III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing

charge balance technology for outstanding low on-resistance

and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior

switching performance, and withstand extreme dv/dt rate.

Consequently, SuperFET III MOSFET is very suitable for

various power system for miniaturization and higher efficiency.



# $\begin{array}{l} \textbf{FCPF250N65S3L1} \\ \textbf{N-Channel SuperFET}^{\texttt{R}} \textbf{III MOSFET} \\ \textbf{650 V, 12 A, 250 m} \Omega \end{array}$

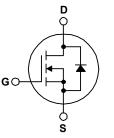
#### Features

- 700 V @ T<sub>J</sub> = 150 <sup>o</sup>C
- Typ. R<sub>DS(on)</sub> = 210 mΩ
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 24 nC)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 248 pF)
- 100% Avalanche Tested
- RoHS Compliant

#### Applications

- Computing / Display Power Supplies
- Telecom / Server Power Supplies
- Industrial Power Supplies





Description

#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

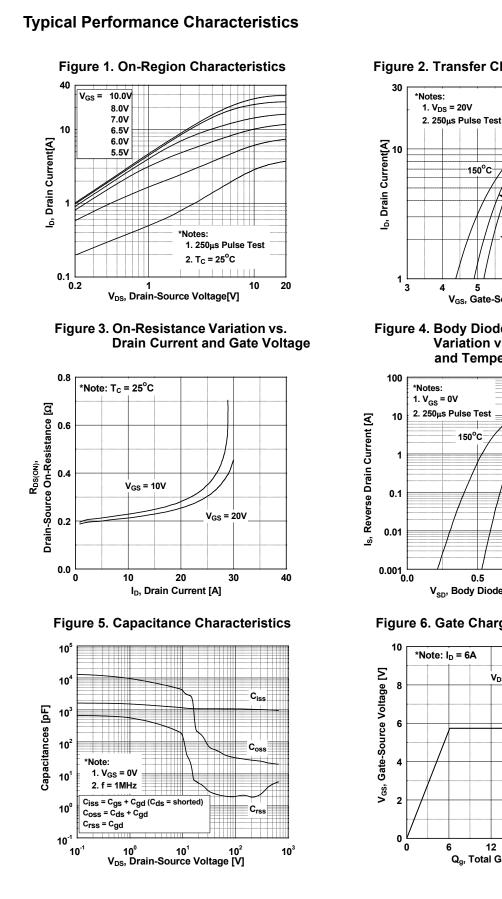
	$ \begin{array}{c} - \text{DC} \\ \hline - \text{AC} \\ - \text{Continuous } (\text{T}_{\text{C}} = 25^{\circ}\text{C} \\ \hline - \text{Continuous } (\text{T}_{\text{C}} = 100^{\circ} \\ \hline - \text{Pulsed} \\ \end{array} $	,	650 ±30 ±20 12* 7.6* 30* 57	V V V A A	
urrent urrent Pulsed Avalanche Ene	- AC - Continuous ( $T_C = 25^{\circ}C$ - Continuous ( $T_C = 100^{\circ}C$ - Pulsed	C) C) (Note 1)	±30 12* 7.6* 30*	V - A	
urrent urrent Pulsed Avalanche Ene	- Continuous ( $T_C = 25^{\circ}C$ - Continuous ( $T_C = 100^{\circ}C$ - Pulsed	C) C) (Note 1)	12* 7.6* 30*	- A	
urrent Pulsed Avalanche Ene	- Continuous (T <sub>C</sub> = 100 <sup>c</sup> - Pulsed	(Note 1)	7.6* 30*		
urrent Pulsed Avalanche Ene	- Pulsed	(Note 1)	30*		
Pulsed Avalanche Ene		, ,		А	
	ergy	(Note 2)	F7		
sho Curront		Single Pulsed Avalanche Energy (Note 2)			
Avalanche Current (Note 1)			2.3	А	
Repetitive Avalanche Energy (Note 1)			0.31	mJ	
MOSFET dv/dt			100	V/ns	
Peak Diode Recovery dv/dt (Note 3)				v/ns	
Dissingtion	(T <sub>C</sub> = 25 <sup>o</sup> C)		31	W	
Jissipation	- Derate Above 25°C		0.25	W/ºC	
Operating and Storage Temperature Range			-55 to +150	°C	
Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	
	Im Lead Temperature	Dissipation - Derate Above 25°C - Derate Above 25°C - Derate Above 25°C	Dissipation - Derate Above 25°C   ng and Storage Temperature Range   Im Lead Temperature for Soldering, 1/8" from Case for 5 Seconds	Dissipation     - Derate Above 25°C     0.25       ng and Storage Temperature Range     -55 to +150	

### Thermal Characteristics

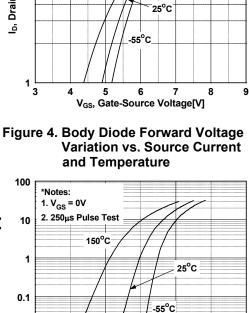
Symbol	Parameter	FCPF250N65S3L1	Unit	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	4.07	0C/M	
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/W	

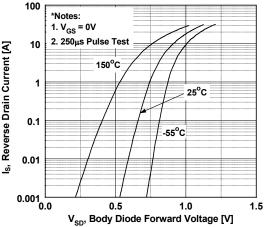
FCPF250N65S3L1
- N-Channel Supe
rFET®
<b>III MOSFET</b>

•		Top Mark	Package	e Packing Method Reel Siz		е	Tape Width	n Qu	Quantity	
		TO-220F				N/A	50	50 units		
Electrica	l Chara	cteristics To = 25	<sup>o</sup> C unless oth	perwise noted		1				
Symbol	Parameter			Test Conditions			Тур.	Max.	Unit	
Off Charao	cteristics									
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage			V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA, T <sub>J</sub> = 25°C			-	-	V	
200	Diamito ot	<u> </u>		$V_{GS}$ = 0 V, I <sub>D</sub> = 1 mA, T <sub>J</sub> = 150°C		700	-	-	V	
∆BV <sub>DSS</sub> / ∆T <sub>J</sub>	Breakdown Voltage Temperature Coefficient		_	$I_D = 1 \text{ mA}$ , Referenced to $25^{\circ}C$			0.67	-	V/ºC	
l	Zero Gate Voltage Drain Current		VD	$V_{DS} = 650 V, V_{GS} = 0 V$ $V_{DS} = 520 V, T_C = 125^{\circ}C$		-	-	1	μA	
DSS			VD			-	0.77	-	μΛ	
I <sub>GSS</sub>	Gate to Body Leakage Current		V <sub>G</sub>	$_{\rm S}$ = ±30 V, V <sub>DS</sub> = 0 V		-	-	±100	nA	
On Charac	cteristics									
V <sub>GS(th)</sub>	Gate Three	shold Voltage	VG	<sub>SS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 1.2 mA		2.5	-	4.5	V	
R <sub>DS(on)</sub>		n to Source On Resista		<sub>is</sub> = 10 V, I <sub>D</sub> = 6 A		-	210	250	mΩ	
9FS	Forward T	ransconductance	VD	<sub>os</sub> = 20 V, I <sub>D</sub> = 6 A		-	7.4	-	S	
Ovnamic (	Characteri	stics								
C <sub>iss</sub>	Input Capa		Vn	<sub>os</sub> = 400 V, V <sub>GS</sub> = 0 V,		-	1010	-	pF	
C <sub>oss</sub>	Output Ca	pacitance		1 MHz		-	25	-	pF	
C <sub>oss(eff.)</sub>	Effective C	output Capacitance	VD	$_{\rm OS}$ = 0 V to 400 V, V <sub>GS</sub>	= 0 V	-	248	-	pF	
C <sub>oss(er.)</sub>	Energy Re	lated Output Capacitar		$_{\rm OS}$ = 0 V to 400 V, V <sub>GS</sub>		-	33	-	pF	
Q <sub>g(tot)</sub>	Total Gate	Charge at 10V	VD	<sub>os</sub> = 400 V, I <sub>D</sub> = 6 A,		-	24	-	nC	
Q <sub>gs</sub>	Gate to So	urce Gate Charge		<sub>SS</sub> = 10 V		-	6.1	-	nC	
Q <sub>gd</sub>	Gate to Dr	ain "Miller" Charge			(Note 4)	-	9.7	-	nC	
ESR	Equivalent	Series Resistance	f =	1 MHz		-	8.7	-	Ω	
Switching	Characte	ristics								
d(on)	Turn-On D	elay Time				-	18	-	ns	
r	Turn-On R	ise Time		$V_{DD}$ = 400 V, I <sub>D</sub> = 6 A, $V_{GS}$ = 10 V, R <sub>g</sub> = 4.7 $\Omega$ (Note 4)		-	18	-	ns	
d(off)	Turn-Off D	elay Time	V <sub>G</sub>			-	49	-	ns	
f	Turn-Off Fa	all Time				-	12	-	ns	
Source-Dr	ain Diode	Characteristics	·							
s	Maximum Continuous Drain to Source Diode Forward Current				-	-	12	Α		
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Fo			orward Current		-	-	30	Α	
V <sub>SD</sub>	Drain to Sc	ource Diode Forward Vo	oltage V <sub>G</sub>	<sub>iS</sub> = 0 V, I <sub>SD</sub> = 6 A		-	-	1.2	V	
lrr	Reverse R	ecovery Time		$V_{GS} = 0 V, I_{SD} = 6 A,$		-	251	-	ns	
Q <sub>rr</sub>	Reverse R	ecovery Charge		/dt = 100 A/µs	_	-	3.4	-	μC	
. I <sub>AS</sub> = 2.3 A, R <sub>G</sub> . I <sub>SD</sub> ≤ 6 A, di/dt	= 25 Ω, starting 1 ≤ 200 A/μs, V <sub>DD</sub> ≤	ited by maximum junction tem; ⁻」 = 25°C. ≨ 400 V, starting T」 = 25°C. ting temperature typical chara								

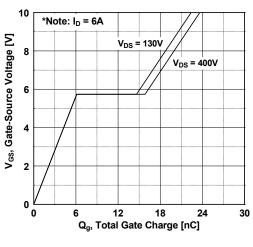


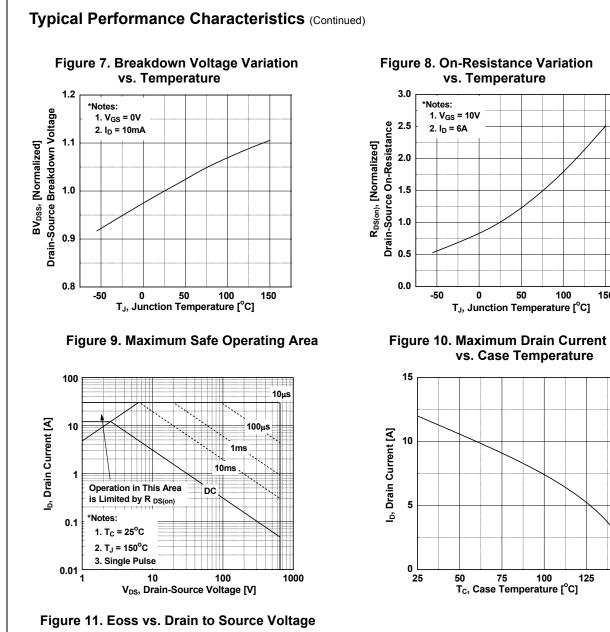
#### **Figure 2. Transfer Characteristics**

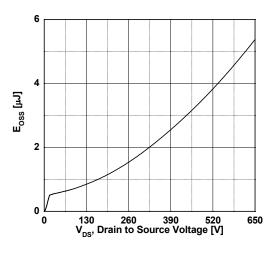




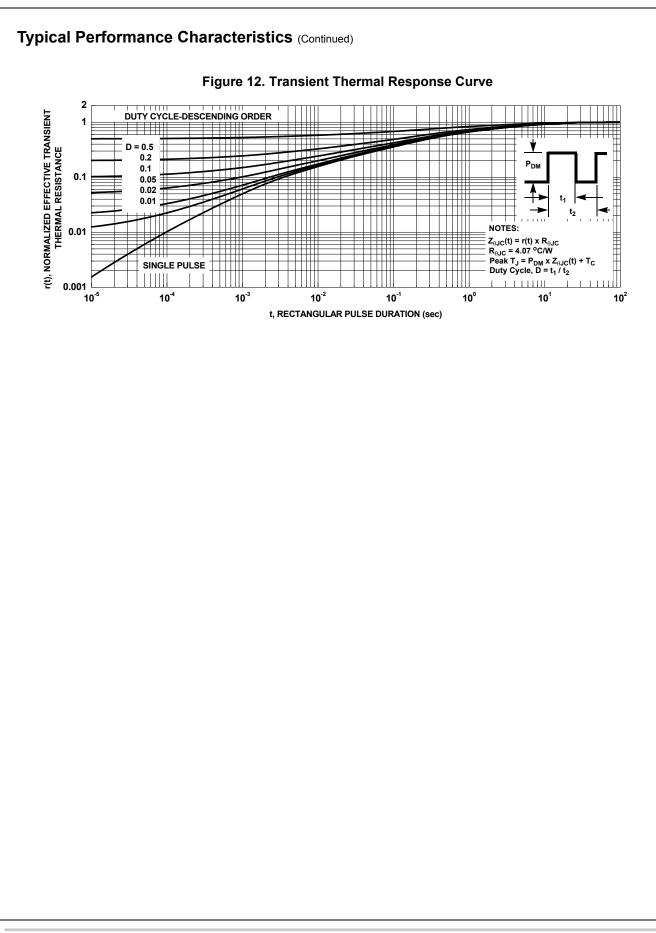


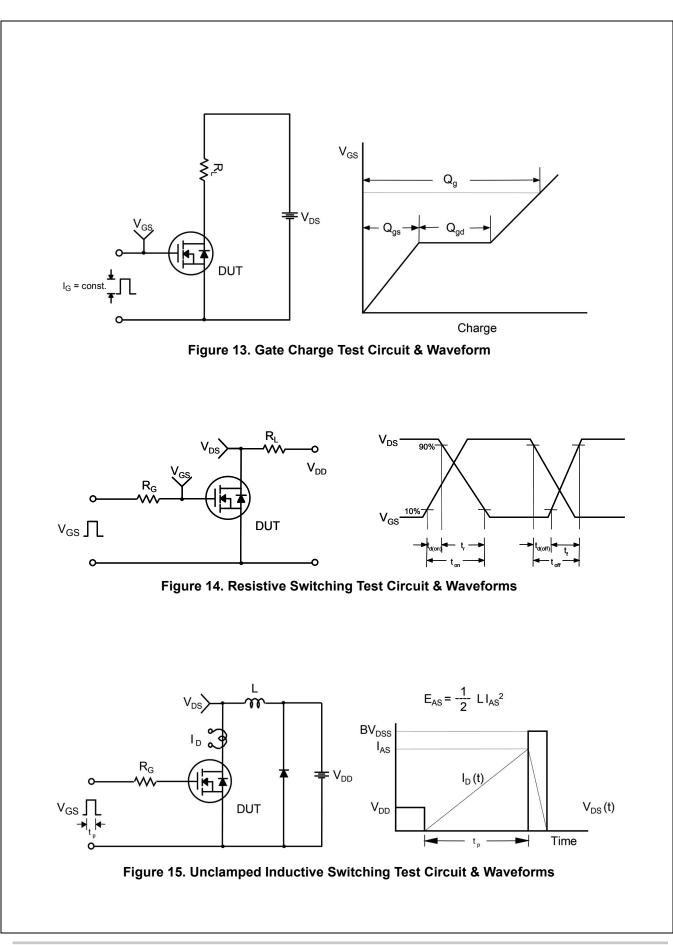






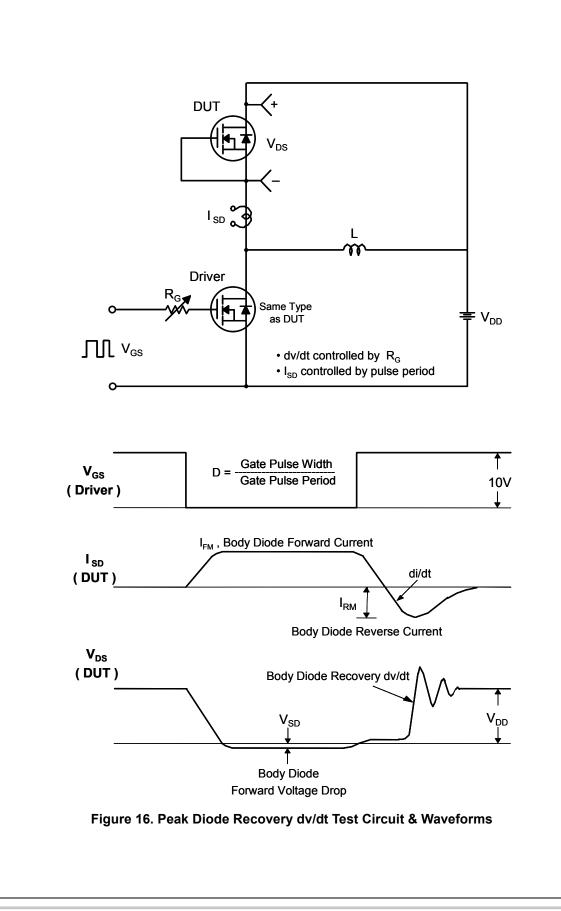
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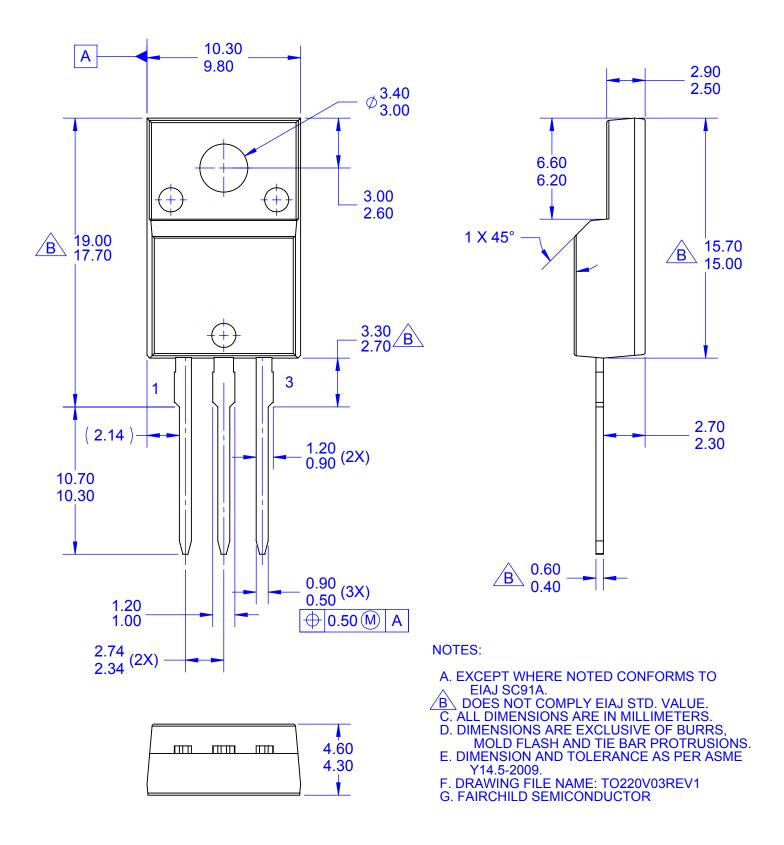




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